Name(s) of CONVEYING Party or Parties:	(Parties):
Se Aug Jang Young Bog Kim In Seok Yeo Jong Choul Kim	Hyundai Electronics Industries Co. Ltd. San 136-1, Ami-ri, Bubal-eub, Ichon-shi, Kyoungki-do, Korea
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correct, and any attached copy is a true copy of the o	knowledge and belief, the foregoing information is true and riginal docyment. If the form
Allen S. Melser, 27,215	May 4, 1998 ignature Reg. No. 28, 264 Date
Name of Person Signing	ignature Reg. No. 28, 264 Date
Attorney Docket No. <u>18298.194</u> Total nu	umber of pages submitted (including cover sheet): <u>2</u>
Commissioner of Patents and Trademarks.	3OX ASSIGNMENTS, Washington, D.C. 20231
	PATENT

## ASSIGNMENT OF UNITED STATES APPLICATION FOR PATENT UNFILED APPLICATION-MULTIPLE INVENTORS

Whereas the undersigned (1) <u>Se Aug JANG</u>, (2) <u>Young Bog KIM</u>, (3) <u>In Seok YEO</u>, and (4) <u>Jong Choul KIM</u>, have invented certain improvements in <u>"METHOD FOR FORMING FIELD OXIDE OF</u> <u>SEMICONDUCTOR DEVICE AND THE SEMICONDUCTOR</u> <u>DEVICE</u>"

for which an application for Letters Patent of the United States of America:

X	was executed on even date herweith	
	was filed onand was assigned Application No	

Whereas, **Hyundai Electronics Industries Co., Ltd.**,(hereinafter referred to as Assignee) a corporation of **Korea** and having an address **San 136-1**, **Ami-ri**, **Bubal-eub**, **Ichon-shi**, **Kyoungki-do**, **Korea**, is desirous of acquiring an interest therein and in the Letters Patent to be obtained therefor:

NOW, THEREFORE, in consideration of One Dollare (\$1.00) and other good and valuable consideration, the receipt of which is hereby acknowledge, the undersigned by these presents, hereby assing, sell and transfer unto the said Assignee, for the territory of the United States of America, all right, title and interest in and to said invention and application, and any and all divisions or continuations thereof, and in and to any Letters Patent that my be granted therefor together with any reissues, extensions or renewals thereof, the same to be held and enjoyed by the Assignee for Assignee's own use and behoof, and for Assignee's legal representatives, successors and assigns, to the full end of the term for which said Letters Patent may be granted, as fully and entirely as the same would have been held by the undersigned had this Assignment and same nto been made: and the udnersigned, and legal representatives thereof, hereby covenant and agree to execute and deliver any and all paters, and do all lawful acts that said Assignee may consider necessary or advisable to perfect title to said invention and to obtain Letters Patent therefor, and agree at any time upon request, to communicate to said Assignee, Assignee's successors, and agree at any time upon request, to communicate to said Assignee, Assignee's successors and assigns, such facts relating to said invetnion and letters Patent or the interferences, opposition as may be known to the undersigned and testify as to the same in any interferences, opposition or other litigation, when requested to do so, all without further consideration than that now paid, but at the expense of the said Assignee, Assignee's successors or assigns.

We authorize our attorneys at REID & PRIEST L.L.P. to insert into this Assignment document any identifying information concerning this patent application, such as its title, filing date and application number.

9. A. Jang Se Aug JANG

First Inventor Se Aug

Y.B. Kim

Second Inventor Young Bog KIM

Seck

Third Inventor In Seok YEO

Jong Chal Kin

Fourth Inventor Jong Choul KIM

December 11, 1997 Date

**December 11, 1997** Date

December 11, 1997 Date

December 11, 1997 Date

REID & PRIEST L.L.P. 701 PENNSYLVANIA AVENUE NW SUITE 800 WASHINGTON, D.C. 20004 (202) 508-4000

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